

CUS02

Switching Mode Power Supply Applications

Portable Equipment Battery Applications

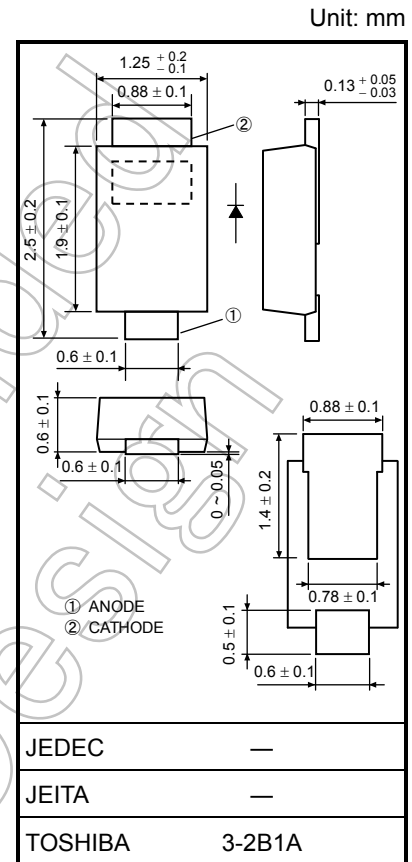
- Peak forward voltage: $V_{FM} = 0.45 \text{ V}@I_F = 0.7 \text{ A}$
- Average forward current: $I_F (AV) = 1.0 \text{ A}$
- Repetitive peak reverse voltage: $V_{RRM} = 30 \text{ V}$
- Suitable for high-density board assembly due to the use of a small surface-mount package, US-FLAT™

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	V_{RRM}	30	V
Average forward current	$I_F (AV)$	1.0 (Note 1)	A
Peak one cycle surge forward current (non-repetitive)	I_{FSM}	20 (50 Hz)	A
Junction temperature	T_j	-40 to 150	°C
Storage temperature range	T_{stg}	-40 to 150	°C

Note 1: Ta = 25°C: Device mounted on a glass-epoxy board
 Board size: 50 mm × 50 mm,
 Land size: 6 mm × 6 mm
 Rectangular waveform ($\alpha = 180^\circ$), $V_R = 15 \text{ V}$

Note 2: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
 Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



Weight: 0.004 g (typ.)

Electrical Characteristics (Ta = 25°C)

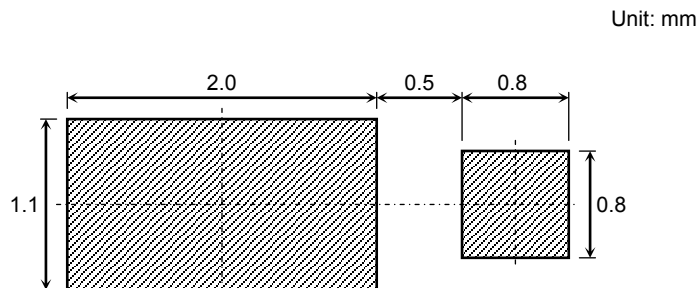
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Peak forward voltage	$V_{FM(1)}$	$I_{FM} = 0.1 \text{ A}$	—	0.35	—	V
	$V_{FM(2)}$	$I_{FM} = 0.7 \text{ A}$	—	0.42	0.45	
	$V_{FM(3)}$	$I_{FM} = 1.0 \text{ A}$	—	0.47	—	
Repetitive peak reverse current	$I_{RRM(1)}$	$V_{RRM} = 5 \text{ V}$	—	0.7	—	μA
	$I_{RRM(2)}$	$V_{RRM} = 30 \text{ V}$	—	10	100	
Junction capacitance	C_j	$V_R = 10 \text{ V}, f = 1.0 \text{ MHz}$	—	40	—	pF
Thermal resistance (junction to ambient)	$R_{th(j-a)}$	Device mounted on a ceramic board (Board size: 50 mm × 50 mm, Land size: 2 mm × 2 mm)	—	—	75	°C/W
		Device mounted on a glass-epoxy board (Board size: 50 mm × 50 mm, Land size: 6 mm × 6 mm)	—	—	150	
Thermal resistance (junction to lead)	$R_{th(j-t)}$	Junction to lead of cathode side	—	—	30	°C/W

Start of commercial production
2001-12

Marking

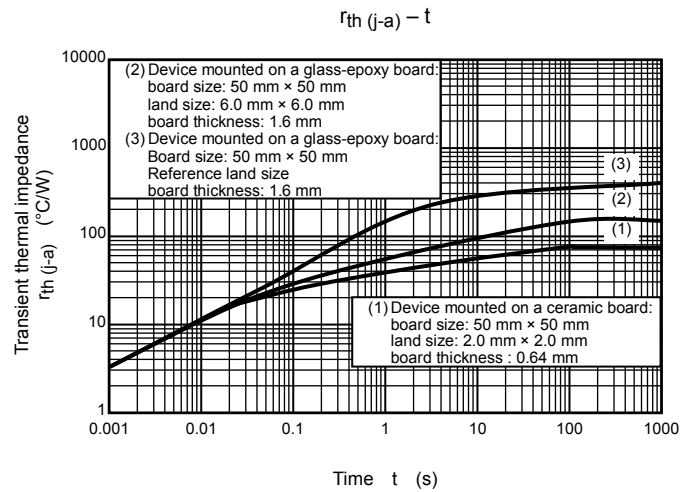
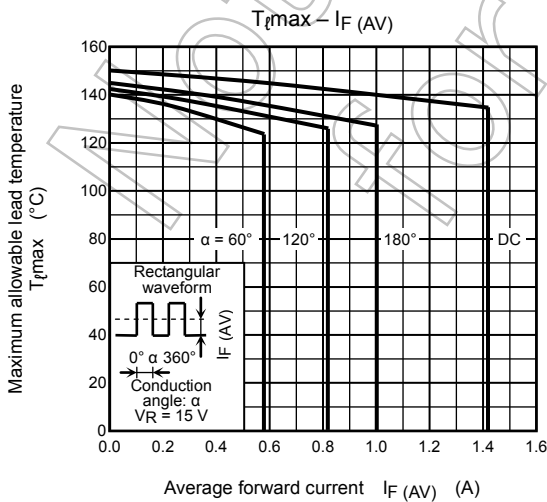
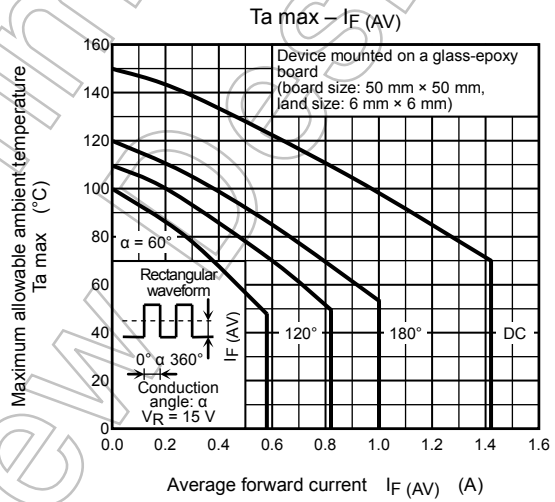
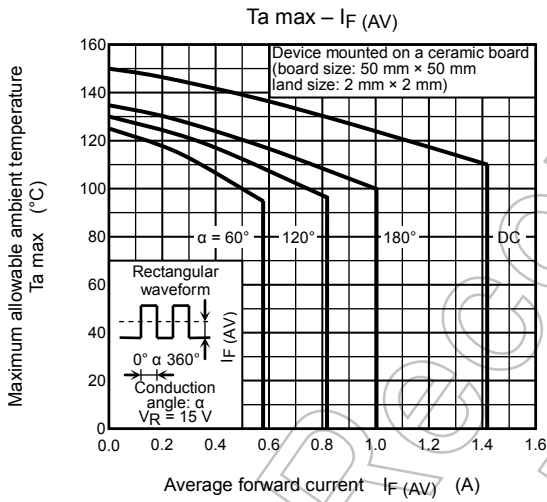
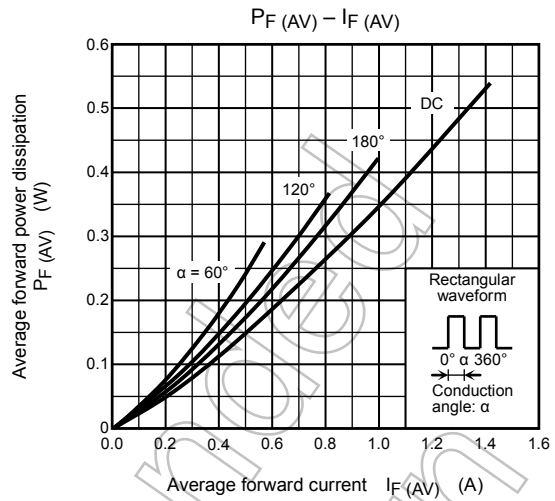
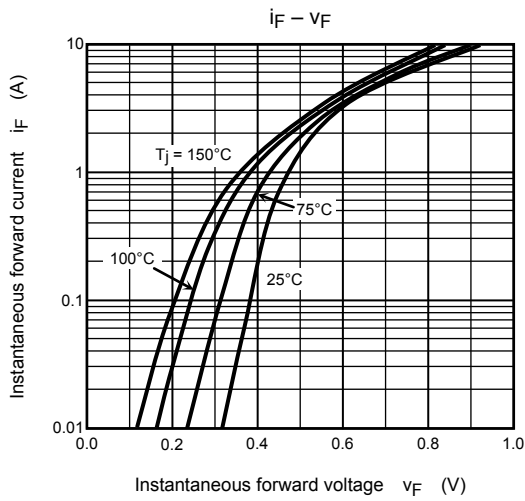
Abbreviation Code	Part No.
2	CUS02

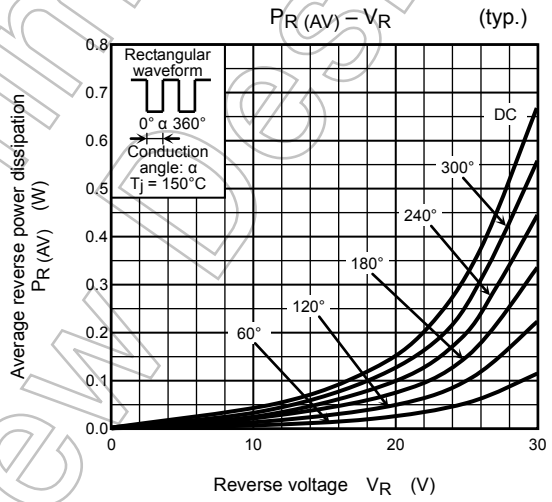
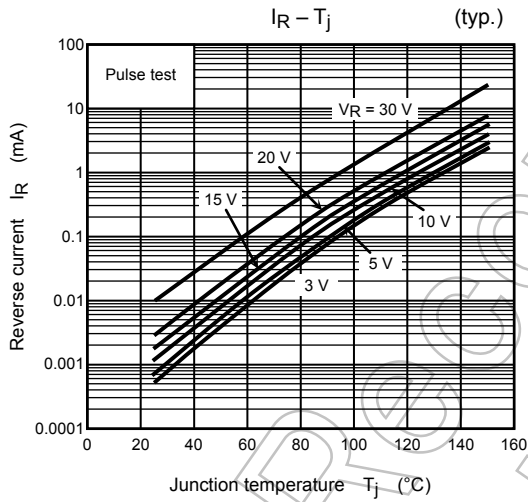
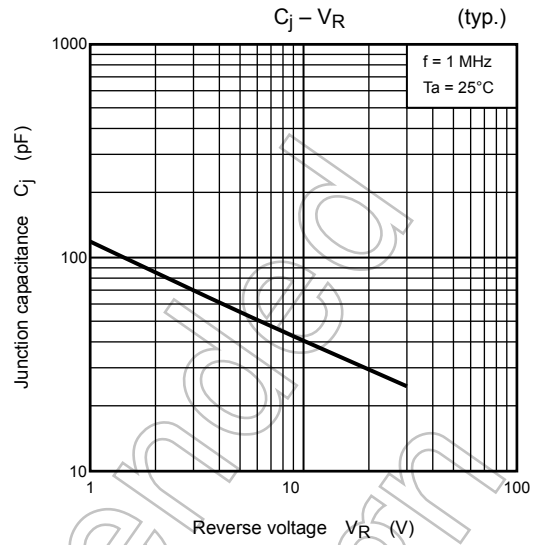
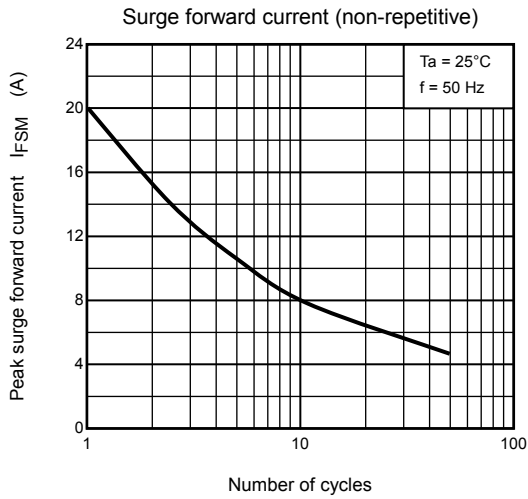
Land pattern dimensions for reference only



Handling Precaution

- 1) Schottky barrier diodes have reverse current characteristics compared to other diodes. There is a possibility SBD may cause thermal runaway when it is used under high temperature or high voltage. Please take forward and reverse loss into consideration during design.
- 2) The absolute maximum ratings denote the absolute maximum ratings, which are rated values and must not be exceeded during operation, even for an instant. The following are the general derating methods that we recommend for designing a circuit using this device.
 - VRRM: Use this rating with reference to the 1). VRRM has a temperature coefficient of 0.1%/°C. Take this temperature coefficient into account designing a device at low temperature.
 - I_{F(AV)}: The worst-case current is no greater than 80% of the absolute maximum rating of I_{F(AV)} and T_j be below 120°C. When using this device, take the margin into consideration by using an allowable T_a max-I_{F(AV)} curve.
 - I_{FSM}: This rating specifies the non-repetitive peak current. This is only applied for an abnormal operation, which seldom occurs during the lifespan of the device.
 - T_j: Derate this rating when using a device in order to ensure high reliability. The device is used at T_j below 120°C.
- 3) Thermal resistance between junction and ambient fluctuates depending on the device's mounting condition. When using a device, design a circuit board and a soldering land size to match the appropriate thermal resistance value.
- 4) Refer to the Rectifiers databook for further information.





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